

0.50 THR type Connector Restricted to TOYOTA MOTOR CORPORATION (TMC) and any electric equipment supplier to supply for TMC. (トヨタ自動車株式会社、およびトヨタ自動車株式会社への納入を目的とする供給者 限定)

1. SCOPE:

1.1. Contents

This specification covers the requirements for product performance,

test methods and quality assurance provisions of 0.50 Series unsealed Connectors. Applicable product description and part numbers are as shown in Appendix 1.

2. APPLICABLE DOCUMENTS:

The following documents form a part of this specification to the extent specified herein.

In the event of conflict between the requirements of this specification and the product drawing, the product drawing shall take precedence.

In the event of conflict between the requirements of this specification and the referenced documents, this specification shall take precedence.

2.1. TE Specifications:

Α.	109-1	Test Specification, General Requirements for Testing
В.	114-5379	Application Specification: Crimping of 0.50 Receptacle Contact
C.	501-78583	Qualification Test Report: 0.50 Series Connectors (THR Type)

- 2.2. Commercial Standards and Specifications:
 - A. JASO D605 Multi-pole Connector for Automobiles
 - B. JASO D7101 Test Methods for Plastic Molded Parts
 - C. JIS C3406 Low Voltage Wires and Cables for Automobiles
 - D. JIS D0203 Method of Moisture, Rain and Spray Test for Automobile Parts
 - E. JIS D0204 Method of High and Low Temperature Test for Automobile Parts
 - F. JIS D1601 Vibration Testing Method for Automobile Parts
 - G. JIS R5210 Portland cement
 - H. MIL-STD-202 Testing Method 208 : Method of Soldering



3. **REQUIREMENTS**:

3.1. Design and Construction:

Product shall be of the design, construction and physical dimensions specified on the applicable product drawing.

3.2. Materials:

A. Contact

Description	Material	Finish
Tab(Male)	Brass	part of Post-Tinned(nickel under plating) or Selective Gold(nickel under plating)
Receptacle(Female)	Copper Alloy	Pre-Tinned or Selective Gold

Fig.1

B. Board lock

Description	Material	Finish
Boardlock	Brass	Post-Tinned(nickel under plating)

Fig.2

C. Housing: SPS resin

D. Wire: The used wire is according to the following table

Tab Wire used						
0.50 0.35mm ² (Applicable wire refer to 114-5379)						
Fig.3						

3.3. Ratings:

nau	nys.	
Α.	Voltage Rating:	12 V DC
В.	Temperature Rating:	-30° ℃ ~85° ℃

3.4. Performance Requirements and Test Descriptions :

The product shall be designed to meet the electrical,

mechanical and environmental performance requirements specified in Fig.4 and Fig5. All tests shall be performed in the room temperature, unless otherwise specified.



3.5. Test Requirements and Procedures Summary :

Para.	Test Items	Rec	quirements	Pro	cedı	ures	
3.5.1	Confirmation of Product	Meets requiremer and TE Specificat	nts of product drawing tion 114-5379	Visually ,dimensionally and functionally inspected per applicable quality inspection plan			
	1	E	lectrical Requirements	T			
3.5.2	Termination Resistance	Initial	10 mΩ Max.	Subject mated contacts mV Max. Closed circuit a		-	
0.0.2	(Low Level)	Final	Fig. 6				
3.5.3	Termination Resistance	Initial	Subject mated contacts V Max. Closed circuit at		embled in housing to 12		
	(Specified Current)	Final	20 mV/A Max.	Fig. 6			
3.5.4	Dielectric Withstanding Voltage	No creeping disc shall occur.	harge or flashover	Impressed voltage 1kV Use mated connector. Fig.7	AC 1	for 1 min.	
3.5.5	Insulation Resistance	100 MΩ Min. (Ini 100 MΩ Min. (Fir		Impressed voltage 500 Use mated connector. Fig. 7	VDC)	
3.5.6	Current Leakage	3mA Max.		Impressed voltage 14VDC Fig. 8			
3.5.7	Temperature Rise	60°C Max.		Measure temperature rising at wire crimped by applied current to single position and all positions. Fig. 12			
3.5.8	Over Current Loading	No ignition is allo	owed during the test.	Apply the current to only one position. Applied Current : Fig.9			
		Р	hysical Requirements				
				Test connector on P. C Mount: Fig. 10	. В		
			continuity greater than	Vibration Frequency(Hi	z)	20→200→20	
3.5.9	Vibration	1µsec. shall occu		Sweep time(min)	/	3	
	(High Frequency)		ents of test item on the	Acceleration(m / s ²)		44.1	
		"3.6 sequence".		Vibration Direction		X, Y, Z	
				Duration		3hours each	
				Test connector on P. C	;. B		
				Mount: method at Fig.	10		
				Acceleration(m/s²)980Duration(msec)6		0	
3.5.10	Shock		continuity greater than				
0.01.0		1µ sec. shall occ	ur.	Waveform			
				Direction and	drops each directions		
			number of Drops of X,-X, Y,-Y,Z and -Z axes, totally 18 drops				
3.5.11	Connector Mating Force	70N Max		Operation Speed : 100 Measure the force require			
	Connector Linmating	70N Max		Operation Speed : 100mm / min.			
3.5.12	Connector Unmating Force			Measure the force required to unmate			
				connectors. (without housing lock)			

Fig.4 (To be continued)



Para.	Test Items	Req	uirements		Procedures				
		Ph	ysical Requi	rements					
3.5.13	Connector Locking Strength	100N Min.			Apply an axial pull-off load to one of the mated housing, measure locking strength. Operation Speed : 100mm/min.				
3.5.14	Terminal Insertion Force into Plug housing	10N Max. (per 1	terminal)		Measured insertion force housing.	of terminal i	fitting into		
3.5.15	Terminal Retention Force (at final locked position)	40N Min.			Measure contact retention lock set it effect. Operation				
		Wire size	Tensile St	trength (N)	Apply an axial pull-off lo	ad to crimp	ed wire of		
		(mm ²)	Initial	Final	contact secured on the t	ester.			
3.5.16	Crimp tensile strength	0.35	50 Min.	40 Min.	Release the insulation b Operation speed: 100m				
3.5.17	Tab Retention Force	3N Min			Push tab contact from P. mating side, measure the Operation speed: 100m	contact ret			
3.5.18	Resistance to "Kojiri"	Satisfy requirem "3.6 sequence".	ents of test i	item on the	Repeated mating-unmating by hand in up-down and right-left directions for 10 cycles.				
					Test condition is according to the following table				
		Wet Solder Cove	erage (only t	he plating	Solder	Sn-3Ag-0.5Cu			
3.5.19	Solder ability	side) : 95 % Min.			Solder temperature(°C)	250±5			
		(with under plating	ng)		Immersion duration(s)	5±0.5			
					Flux	ULF-300R			
		Tab retention for	ce satisfying	g follows.	After the soldering, go on test after cooling to the room temperature. See 3.5.17 Tab retention force.				
3.5.20	Resistance to Soldering				Solder	Sn-3Ag-0.5Cu			
	Heat				Solder temperature	260±5℃			
		3N Min			Immersion duration	10±1 sec			
					Flux	ULF-300R			
3.5.21	Handling Ergonomics		abnormalities allowed in manual ting / unmating handling.						
					[1],[2] in the following table as one cycle.				
					Repeat 1000 cycles.				
					Monitor resistance-varia	tion at clos	ed circuit		
3.5.22	Thermal Shock	Satisfy requirem	ents of test i	item on the	current of 10mA during				
5.0. LL		"3.6 sequence".				[1]	[2]		
					Time(hr)	0.5	0.5		
					Temperature	80±3	0.0		

Fig.4 (To be continued)



Para.	Test Items	Requirements	Procedures				
		Environmental Requirements	5				
3.5.23	Humidity (Steady State)	Satisfy requirements of test item on the "3.6 sequence". Current Leakage: 3mA Max.	Test condition is shown Monitor current leakag Time(Hr) Temperature(°C) Humidity(%RH)		96 60±2		
3.5.24	Industrial Gas (SO ₂)	Satisfy requirements of test item on the "3.6 sequence".	Using unmated connect	sof mated coni SO ₂ 25	mated connector after SO ₂ 25 Room temperature 75		
3.5.25	Temperature Life (Heat Aging)	Satisfy requirements of test item on the "3.6 sequence".	100°C±3°C, 120hours				
3.5.26	Resistance to Cold	Satisfy requirements of test item on the "3.6 sequence".	-30°C±3°C, 120hours				
3.5.27	Humidity-Temperature Cycling	Satisfy requirements of test item on the "3.6 sequence".	Condition : Fig. 11 Making this condition a cycle, repeated 10 cycles. Monitor fluctuation of electrical resistance at 10mA current loaded during the test.				
3.5.28	Dust Bombardment	Satisfy requirements of test item on the "3.6 sequence".	Subject JIS R 5210 cement blow of 1.5kg per 10 seconds in 15 minutes intervals for 8 cycles, with mating/unmating per 2 cycles.				
3.5.29	Compound Environment Resistance	Satisfy requirements of test item on the "3.6 sequence". No electrical discontinuity greater than 1 μ sec. shall occur.	Test condition is shown Monitor resistance-vari check if instant cutoff of vibration". Temperature(°C) Vibration Frequency(Hz) Sweep time(min) Acceleration(m/s ²) Vibration Direction Duration(Hr) Test Current Method of fixation	n in the followin iation, and afte	or this test our on "3.5.9		
3.5.30	Condensation	Satisfy requirements of test item on the "3.6 sequence".	[1],[2] in the following t 48 cycles. move [1] to Monitor current leakag Time(Hr) Temperature(°C) Humidity(%RH) Current loaded				

Fig. 4 (End)



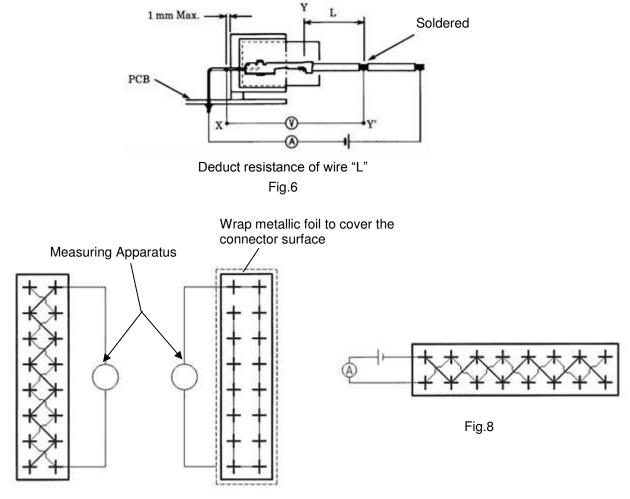
3.6. Product Qualification Test Sequence

		Test Group															
No.	Test Examination	1	2	3	4	5	6	7	8	9	10	11	12	13	14	15	16
								Т	est Se	quence	*						
3.5.1	Examination of Product	1, 3	1, 3	1, 3	1, 5	1, 6	1, 4	1, 5	1, 5	1, 8	1, 5	1, 6	1, 3	1, 7	1, 5	1, 7	1, 5
3.5.2	Termination Resistance (Low Level)	6			2, 6	2, 7		2, 6	2, 6	2, 9	2, 6	2, 7		2, 8	2, 6	2, 8	
3.5.3	Termination Resistance (Specified Current)	7			3, 7	3, 8		3, 7	3, 7	3, 10	3, 7	3, 8		3, 9	3, 7	3, 9	
3.5.4	Dielectric with standing Voltage	9								5, 12				5, 11			
3.5.5	Insulation Resistance	8								4, 11				4, 10			2, 6
3.5.6	Current Leakage									7							4
3.5.7	Temperature Rising	10										4, 9				5	
3.5.8	Over Current Loading				4												
3.5.9	Vibration (High Frequency)					5										6	
3.5.10	Physical Shock						3										
3.5.11	Connector Mating Force	5															
3.5.12	Connector Unmating Force	11															
3.5.13	Connector Locking Strength			2					9	13		11		13			
3.5.14	Contact Insertion Force	4															
3.5.15	Contact Retention Force (Secondary)	12							10	14		12	5	14			
3.5.16	Crimp Tensile Strength	13							11		8	13					
3.5.17	Tab retention force	14															
3.5.18	Resistance to "Kojiri"							4									
3.5.19	Solderbility	2															
3.5.20	Resistance to Soldering Heat		2														
3.5.21	Handling Ergonomics		4						8			10	4	12			
3.5.22	Thermal Shock								4								
3.5.23	Humidity(Steady State)									6							
3.5.24	Industrial SO ₂ Gas										4						
3.5.25	Temperature Life (Heat Aging)					4	2					5					_
3.5.26	Resistance to Cold												2				
3.5.27	Humidity-Temperature Cycling													6			
3.5.28	Dust Bombardment														4		
3.5.29	Compound environment resistance															4	
3.5.30	Condensation																3

*Numbers indicate sequence in which tests are performed.



Product Specification 製品規格



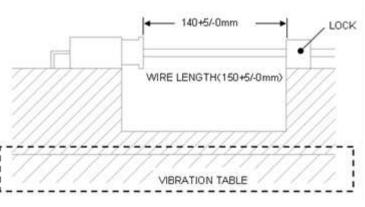
Adjacent Contacts

Fig.7

Contacts - Housing

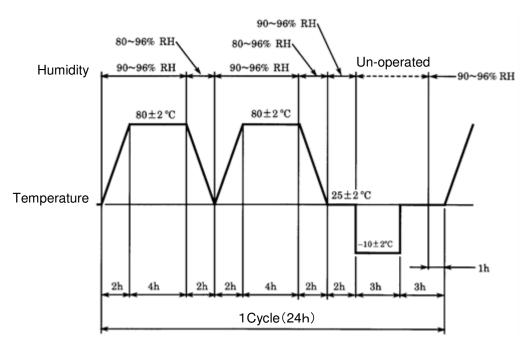
Wire Size (mm ²)	Туре	Test Current (A)	Duration
	1		60 min.
0.35	2	13.5	10 sec.
	3	15.0	5 sec.
	4	20.0	1 sec.











Contact(mm²)Single PosAll Pos(\angle t)0.500.3551.560°C Max.	Contact	Wire Size	Test C	Currnet(A)	Temperature Rise
0.50 0.35 5 1.5 60°C Max.	Contact	(mm²)	Single Pos	All Pos	(⊿t)
	0.50	0.35	5	1.5	60°C Max.

Fig.12

Contact	Wire Size (mm ²)	Test Currnet(A)	Test time
0.50	0.35	1.2	45 min ON、15 min OFF for one cycle. 300 cycles operation

Fig.13



Applicable	product and	part number	is appendix 1.
, applicable	product and	partmannoor	ie appendix ii

Product Part No.*1	Description			
○Cap Assembly (Male Connector)				
2201816	0.50 75Pos(21Pos+27Pos+27Pos) Cap Assembly			
2260992	0.50 78Pos(21Pos+30Pos+27Pos) Cap Assembly			
2298340* ²	0.50/0.64 56Pos(21Pos+27Pos+8Pos) Cap Assembly			
2300181* ²	0.50/0.64 104Pos(21Pos+27Pos+21Pos+27Pos+8Pos) Cap Assembly			
OPlug Assembly (Female Connector)				
2229097	0.50 21Pos Plug Assembly			
2229101	0.50 27Pos Plug Assembly			
2822015	2822015 0.50 30Pos Plug Assembly			
OReceptacle Contact (Female Contact)				
1827855	0.50 Receptacle Contact (S) (M) (L) (C) (Post-Tinned)			
1903703	0.50 Receptacle Contact (M) (Selective-Gold)			
Appendix.1				

*1: Part number is consisted from listed base number and 1 digit numeric prefix and suffix with dash. Refer to catalog or customer drawing for specific part numbers for each base number. When prefix is zero, zero and dash are omitted.

*2: See 108-140151 for 0.64III 8Pos Plug Assembly